

A
BACHELOR'S DEGREE IN TELECOMMUNICATION ENGINEERING

Bachelor's Thesis

ACADEMIC COURSE 2021/2022

Tree Inspection Kit handheld device

AUTHOR:

Juan Del Pino Mena

SUPERVISED BY:

Sr. Andrés Roldán Aranda

DEPARTMENT:

Electronics and Computer Technology



UNIVERSIDAD
DE GRANADA



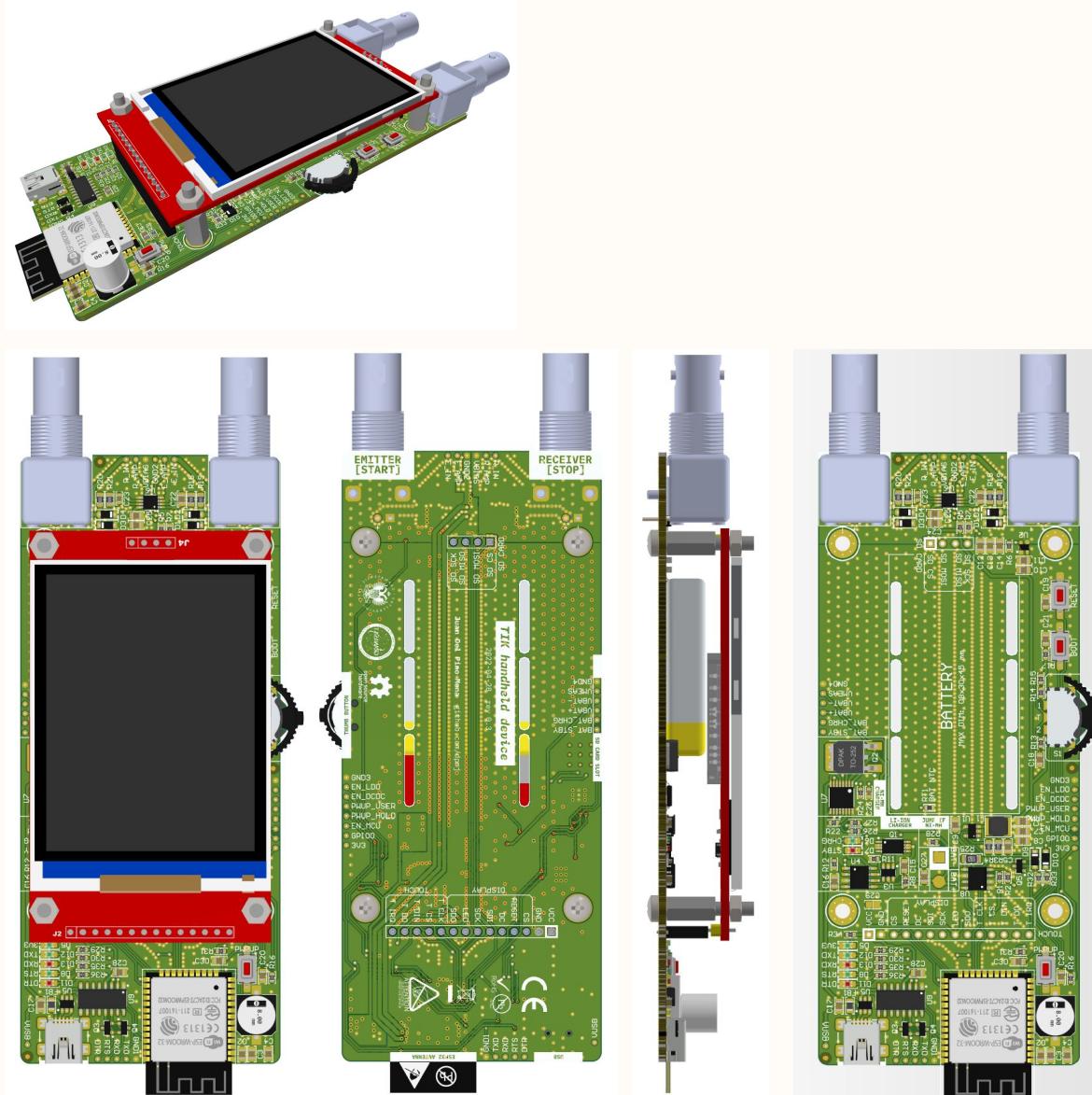
Project title: **TIK_HandheldDevice.PjPcb**

Date: **2022-05-12** Revision: **0.4-WIP**

Sheet 1 of 18

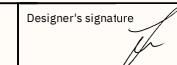
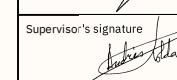
Index

SECTION	PAGE
1. Introduction + Index + PCB renders	2
2. Changelog	3
3. PCB trace width	4
4. Block diagram	5
5. ESP32 MCU	6
6. Power rails	7
7. Battery and current sense	8
7.1. Charger variant #1: Ni-MH	9
7.2. Charger variant #2: Li-Ion	10
8. USB port	11
9. Programming	12
10. Buttons	13
11. TFT LCD Display	14
12. Signal conditioning	15
12.1 Conditioning circuit	15
12.2 Simulations	16
13. Power budget	17
14. Bill of materials	18
15. PCB renders	19
15.1. Top	19
15.2. Bottom	20
16. PCB 3D	21
17. PCB prints	22
17.1. Top	22
17.2. Bottom	23
18. Mechanical schematics	24



Tree Inspection Kit handheld device

*
*

Designer's signature

Supervisor's signature


Sheet title: **Introduction and PCB renders**
Project title: **TIK_HandheldDevice.PxjPcb**

Designer: **Juan Del Pino Mena**

Date: **2022-05-12** Revision: **0.4-WIP** Sheet 2 of 18

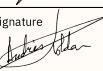
Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain



A	<p># Revision 0.4 2022-05-11 [MOST RECENT] [WIP]</p> <table border="1"> <thead> <tr> <th>NEW</th><th>FIXED</th></tr> </thead> <tbody> <tr> <td> <ul style="list-style-type: none"> - Added fabrication groups and fabrication order parameters - Added a Bill of Materials. The one in this document is simple. Refer to the manually configured BOM of this project. - Added a PCB track legend and description for visible layers on every PDF exported sheet. </td><td> <ul style="list-style-type: none"> - Corrected I2C pins on the ESP32. - Removed "same length" directive on UART and I2C nets. - Improved routing. - Removed I2C traces' via shielding. - Solved all DRC warnings and errors. </td></tr> </tbody> </table>	NEW	FIXED	<ul style="list-style-type: none"> - Added fabrication groups and fabrication order parameters - Added a Bill of Materials. The one in this document is simple. Refer to the manually configured BOM of this project. - Added a PCB track legend and description for visible layers on every PDF exported sheet. 	<ul style="list-style-type: none"> - Corrected I2C pins on the ESP32. - Removed "same length" directive on UART and I2C nets. - Improved routing. - Removed I2C traces' via shielding. - Solved all DRC warnings and errors. 	<p># Revision 0.2 2022-04-23</p> <table border="1"> <thead> <tr> <th>NEW</th><th>FIXED</th></tr> </thead> <tbody> <tr> <td></td><td> <ul style="list-style-type: none"> - New schematic hierarchy and system's block diagram. - Initial PCB layout - Added a rotary encoder (vertical). Library contains a 90-degree rotary encoder alternative. - Added a new alternative Ni-MH charger circuit. - Added footprints for all necessary components to the PCB Library. - Added explanatory footprints and photos to schematic ICs. - Added board mounting holes (making use of the TFT LCD module mounting hole positions) - Added test points - Added fiducials - Added a power-up button </td></tr> </tbody> </table>	NEW	FIXED		<ul style="list-style-type: none"> - New schematic hierarchy and system's block diagram. - Initial PCB layout - Added a rotary encoder (vertical). Library contains a 90-degree rotary encoder alternative. - Added a new alternative Ni-MH charger circuit. - Added footprints for all necessary components to the PCB Library. - Added explanatory footprints and photos to schematic ICs. - Added board mounting holes (making use of the TFT LCD module mounting hole positions) - Added test points - Added fiducials - Added a power-up button 	A
NEW	FIXED										
<ul style="list-style-type: none"> - Added fabrication groups and fabrication order parameters - Added a Bill of Materials. The one in this document is simple. Refer to the manually configured BOM of this project. - Added a PCB track legend and description for visible layers on every PDF exported sheet. 	<ul style="list-style-type: none"> - Corrected I2C pins on the ESP32. - Removed "same length" directive on UART and I2C nets. - Improved routing. - Removed I2C traces' via shielding. - Solved all DRC warnings and errors. 										
NEW	FIXED										
	<ul style="list-style-type: none"> - New schematic hierarchy and system's block diagram. - Initial PCB layout - Added a rotary encoder (vertical). Library contains a 90-degree rotary encoder alternative. - Added a new alternative Ni-MH charger circuit. - Added footprints for all necessary components to the PCB Library. - Added explanatory footprints and photos to schematic ICs. - Added board mounting holes (making use of the TFT LCD module mounting hole positions) - Added test points - Added fiducials - Added a power-up button 										
B	<p># Revision 0.3 2022-04-28</p> <table border="1"> <thead> <tr> <th>NEW</th><th>FIXED</th></tr> </thead> <tbody> <tr> <td> <ul style="list-style-type: none"> - Changed rotary encoder vertical for horizontal, side-placed, SMD type multipurpose 'thumb button'. - Added a explanation of PCB trace widths. - Adopted JLCPBCB design rules. - Full PCB component placement and routing, with no important DRC messages. - Added silkscreen logos to the back of the PCB, as well as port markings, information and regulatory graphics: CE, WEEE, ESD sensitive warning and RoHS. </td><td> <ul style="list-style-type: none"> - Changed numerical test point designators to net/rail names, to be quickly identified. - Changed LEDs footprints from 0603 to 0805 - Corrected a faulty connection on the DW01A Lithium battery protection IC. - The MCU has no longer the possibility of cutting battery charge. This is because ENABLE signals worked on 5V logic level and could cause damage to the ESP32. </td></tr> </tbody> </table>	NEW	FIXED	<ul style="list-style-type: none"> - Changed rotary encoder vertical for horizontal, side-placed, SMD type multipurpose 'thumb button'. - Added a explanation of PCB trace widths. - Adopted JLCPBCB design rules. - Full PCB component placement and routing, with no important DRC messages. - Added silkscreen logos to the back of the PCB, as well as port markings, information and regulatory graphics: CE, WEEE, ESD sensitive warning and RoHS. 	<ul style="list-style-type: none"> - Changed numerical test point designators to net/rail names, to be quickly identified. - Changed LEDs footprints from 0603 to 0805 - Corrected a faulty connection on the DW01A Lithium battery protection IC. - The MCU has no longer the possibility of cutting battery charge. This is because ENABLE signals worked on 5V logic level and could cause damage to the ESP32. 	<p># REVISION 0.1 2022-04-01</p> <table border="1"> <thead> <tr> <th>NEW</th></tr> </thead> <tbody> <tr> <td> <ul style="list-style-type: none"> - TFT LCD / SD card connections. - First adequation circuit iteration - LiPo battery charger with TP4056 - Auto programming circuit. </td></tr> </tbody> </table>	NEW	<ul style="list-style-type: none"> - TFT LCD / SD card connections. - First adequation circuit iteration - LiPo battery charger with TP4056 - Auto programming circuit. 	B		
NEW	FIXED										
<ul style="list-style-type: none"> - Changed rotary encoder vertical for horizontal, side-placed, SMD type multipurpose 'thumb button'. - Added a explanation of PCB trace widths. - Adopted JLCPBCB design rules. - Full PCB component placement and routing, with no important DRC messages. - Added silkscreen logos to the back of the PCB, as well as port markings, information and regulatory graphics: CE, WEEE, ESD sensitive warning and RoHS. 	<ul style="list-style-type: none"> - Changed numerical test point designators to net/rail names, to be quickly identified. - Changed LEDs footprints from 0603 to 0805 - Corrected a faulty connection on the DW01A Lithium battery protection IC. - The MCU has no longer the possibility of cutting battery charge. This is because ENABLE signals worked on 5V logic level and could cause damage to the ESP32. 										
NEW											
<ul style="list-style-type: none"> - TFT LCD / SD card connections. - First adequation circuit iteration - LiPo battery charger with TP4056 - Auto programming circuit. 											
C			C								

Revision history

Designer's signature

Supervisor's signature


Sheet title: **Changelog**Project title: **TIK_HandheldDevice.PjPcb**Designer: **Juan Del Pino Mena**Date: **2022-05-12** Revision: **0.4-WIP** Sheet 3 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain



Maximum SPI traces length

Wavelength Calculator

Input Method	Wavelength Information
<input type="radio"/> Period	<input type="radio"/> Er Effective Information
<input checked="" type="radio"/> Frequency	<input type="radio"/> Speed of Light

Frequency: **80 MHz** Units: MHz kHz Hz

Er Eff: **2,8905**

Er Eff Calculator

$\lambda = \frac{C}{f * \sqrt{(ErEff)}}$

Note: Enter an Er Eff of 1 for wavelength in air.

Wavelength Divide: **1/20**

1/20 Wave Length: **11.02083 cm**

Bandwidth & Max Conductor Length

Input Method	Speed of Light
<input type="radio"/> Signal Risetime	<input type="radio"/> Frequency
<input checked="" type="radio"/> Frequency	<input type="radio"/> Units

f Units: MHz kHz Hz

Frequency: **80 MHz**

Full Wavelength (In Air): **374.74057 cm**

Lambda Divide by Factor: **1/20**

Maximum Conductor Length: **18.73703 cm**

Maximum Analog traces length

Wavelength Calculator

Input Method	Wavelength Information
<input type="radio"/> Period	<input type="radio"/> Er Effective Information
<input checked="" type="radio"/> Frequency	<input type="radio"/> Speed of Light

Frequency: **100 KHz** Units: MHz kHz Hz

Er Eff: **3,0832**

Er Eff Calculator

$\lambda = \frac{C}{f * \sqrt{(ErEff)}}$

Note: Enter an Er Eff of 1 for wavelength in air.

Wavelength Divide: **1/20**

1/20 Wave Length: **8536.69684 cm**

Analog signal trace impedance

Conductor Impedance

Conductor Width (W)	Formula Restrictions:
0,8 mm	$0.1 < W/H < 2.0$
Conductor Height (H)	$T = 53\mu m$
1,5 mm	<input type="checkbox"/> Help
Conductor Gap (G)	0,254 mm

W/H = 0.533

Z₀: **60.6257 Ohms**

Power traces conductor characteristics (DC)

0.5 mm wide traces

Conductor Characteristics

Solve For	Plane Present?
<input type="radio"/> Amperage	<input type="radio"/> No
<input type="radio"/> Conductor Width	<input checked="" type="radio"/> Yes

Conductor Width: **0,5 mm**

Conductor Length: **1 mm**

PCB Thickness: **1,6 mm**

Frequency: DC

Distance to Plane: **1,5 mm**

Plating Thickness: Bare PCB
 18um
 35um
 53um
 70um
 88um
 106um
 124um
 142um
 178um

Units: Imperial Metric

Substrate Options: **FR-4 STD**

Material Selection: **FR-4 STD**

Base Copper Weight: **0 um**

Temp Rise (°C): **4,6** Tg (°C): **130**

Temp in (°F) = 18.0

Ambient Temp (°C): **25**

Temp in (°F) = 77.0

Plane Thickness: **0.5oz / 1oz**

2oz

Plating Thickness: Bare PCB
 18um
 35um
 53um
 70um
 88um
 106um
 124um
 142um
 178um

Units: Imperial Metric

Substrate Options: **FR-4 STD**

Material Selection: **FR-4 STD**

Base Copper Weight: **0 um**

Temp Rise (°C): **4,6** Tg (°C): **130**

Temp in (°F) = 18.0

Ambient Temp (°C): **25**

Temp in (°F) = 77.0

Plane Thickness: **0.5oz / 1oz**

2oz

Power Dissipation: **0.00397 Watts**

Conductor DC Resistance: **0.00065 Ohms**

Power Dissipation in dBm: **5.9921 dBm**

Conductor Cross Section: **0.0301 Sq.mm**

Voltage Drop: **0.0016 Volts**

Conductor Current: **2.4647 Amps**

Information: Total Copper Thickness 70 um Via Thermal Resistance N/A

IPC-2152 with modifiers mode Etch Factor: 1:1

Print Solve!

0.35 mm wide traces

Conductor Characteristics

Solve For	Plane Present?
<input type="radio"/> Amperage	<input type="radio"/> No
<input type="radio"/> Conductor Width	<input checked="" type="radio"/> Yes

Conductor Width: **0,35 mm**

Conductor Length: **1 mm**

PCB Thickness: **1,6 mm**

Frequency: DC

Distance to Plane: **1,5 mm**

Plating Thickness: Bare PCB
 18um
 35um
 53um
 70um
 88um
 106um
 124um
 142um
 178um

Units: Imperial Metric

Substrate Options: **FR-4 STD**

Material Selection: **FR-4 STD**

Base Copper Weight: **0 um**

Temp Rise (°C): **4,6** Tg (°C): **130**

Temp in (°F) = 18.0

Ambient Temp (°C): **25**

Temp in (°F) = 77.0

Plane Thickness: **0.5oz / 1oz**

2oz

Power Dissipation: **0.00371 Watts**

Conductor DC Resistance: **0.00100 Ohms**

Power Dissipation in dBm: **5.6940 dBm**

Conductor Cross Section: **0.0196 Sq.mm**

Voltage Drop: **0.0019 Volts**

Conductor Current: **1.9218 Amps**

Information: Total Copper Thickness 70 um Via Thermal Resistance N/A

IPC-2152 with modifiers mode Etch Factor: 1:1

Print Solve!

Via characteristics

Via Characteristics

Via Hole Diameter: **0,3 mm**

Internal Pad Diameter: **0,6 mm**

Ref Plane Opening Diam: **1,016 mm**

Via Height: **1,6 mm**

Via Plating Thickness: **0,035 mm**

Via Capacitance: **0.5893 pF**

Via DC Resistance: **0.00086 Ohms**

Via Inductance: **1.2993 nH**

Resonant Frequency: **5751.849 MHz**

Via Impedance: **46.956 Ohms**

Step Response: **30.4373 ps**

Via Current: **1.9514 Amps**

IPC-2152 with modifiers mode

Trace & via characteristics

Trace width based on results from PCB Toolkit by Saturn PCB Design INC.

*

TO-DO: EXPLAIN DATA.
CROP SOME
SCREENSHOTS

Designer's signature

Sheet title: **Trace width design**

Project title: **TIK_HandheldDevice.PjPcb**

Supervisor's signature

Desinger: **Juan Del Pino Mena**

Date: **2022-05-12**

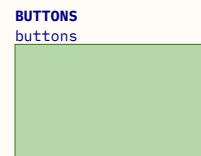
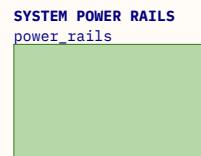
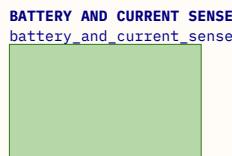
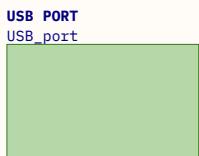
Revision: **0.4-WIP**

Sheet 4 of 18



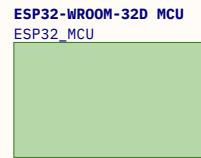
A

A



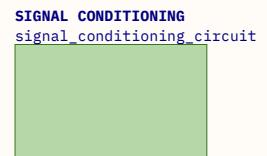
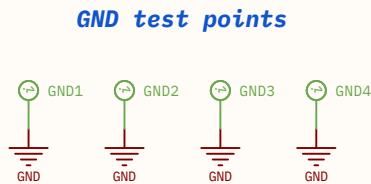
B

B



C

C



D

D

Block diagram

*
*

TO-DO: ARROWS
INDICATING WHERE
SIGNALS GO

Designer's signature

Sheet title: **Block diagram**

Project title: **TIK_HandheldDevice.PrjPcb**

Supervisor's signature

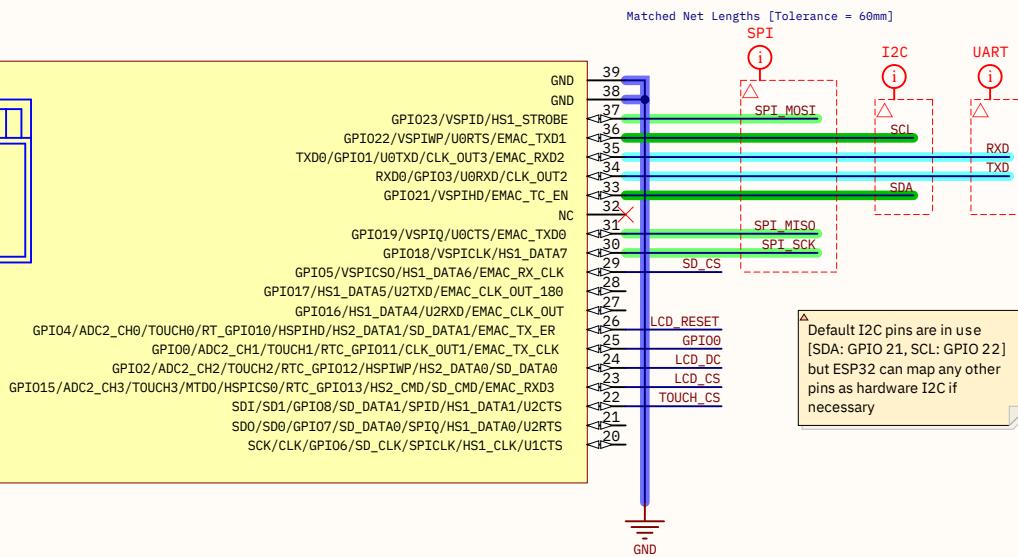
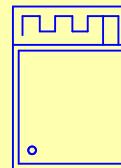
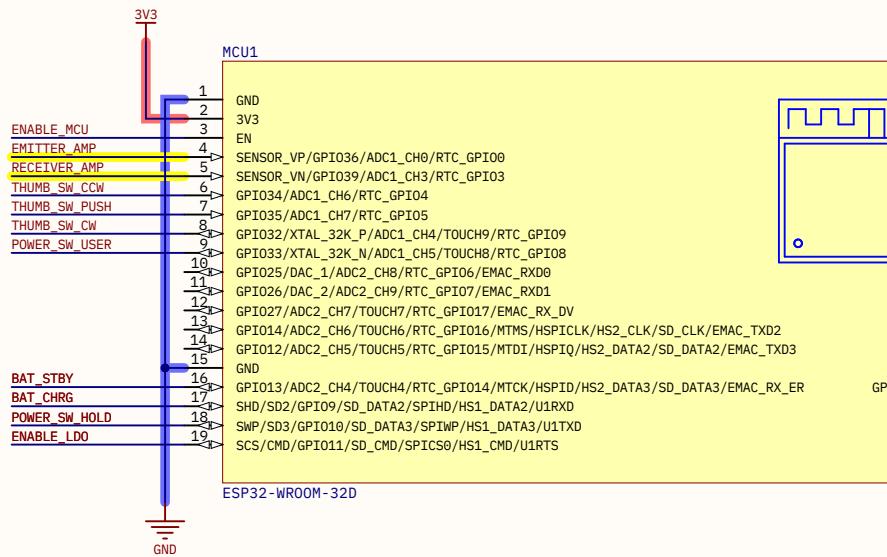
Designer: **Juan Del Pino Mena**

Date: **2022-05-12** Revision: **0.4-WIP** Sheet 5 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología
de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain



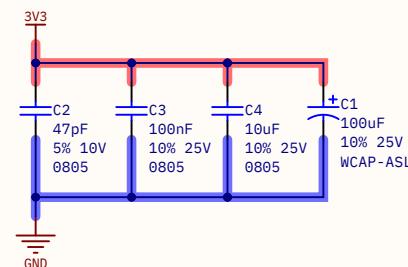
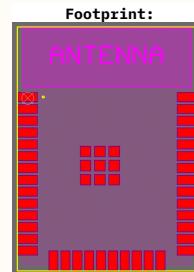
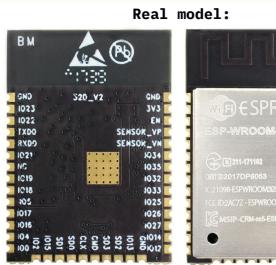
A



Default I2C pins are in use
[SDA: GPIO 21, SCL: GPIO 22]
but ESP32 can map any other
pins as hardware I2C if necessary

ADC2 pins are not
usable while using
Wi-Fi or Bluetooth
and should be left
unused if not
necessary

GPIO34, GPIO35,
GPIO36 & GPIO39
are input-only



Recommended smoothing/bypass capacitors are
0.1 μ F and 10 μ F, ceramic, low ESR. Should be
placed close to the chip and with short return
paths. [ESP32-WROOM-32D datasheet, page 21]

Added one extra 100 μ F electrolytic cap to filter
current spikes during ESP32 RF usage and a
small 47pF capacitor to be more effective on high
frequencies

ESP32-WROOM-32D MCU, Wi-Fi + Bluetooth module

MCU hardware configuration and I/O pins

*

Designer's signature

Sheet title: **ESP32-WROOM-32D MCU**

Project title: **TIK_HandheldDevice.PjPcb**

Supervisor's signature

Desinger: **Juan Del Pino Mena**

Date: **2022-05-12**

Revision: **0.4-WIP**

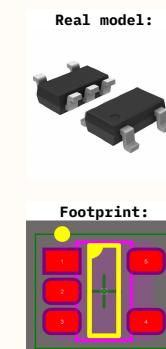
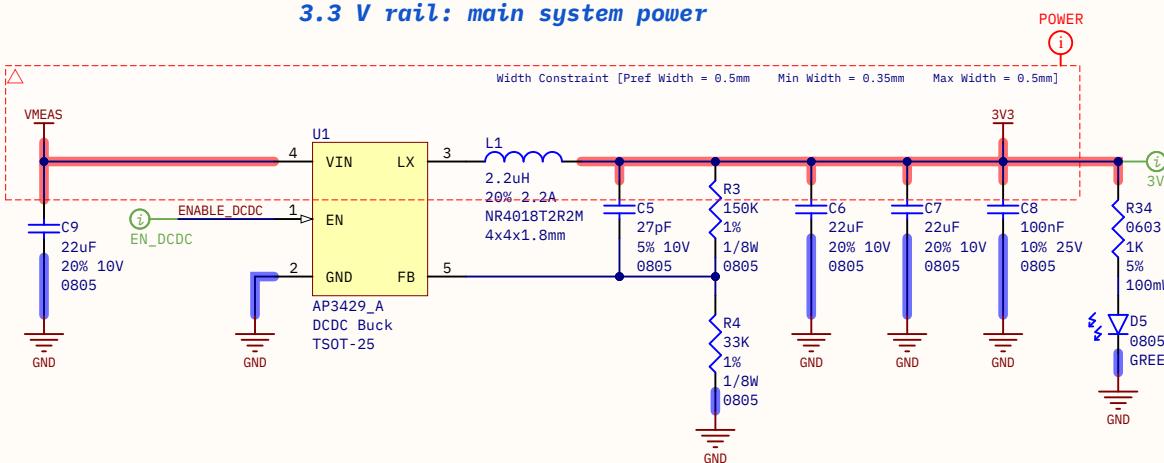
Sheet 6 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología
de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain

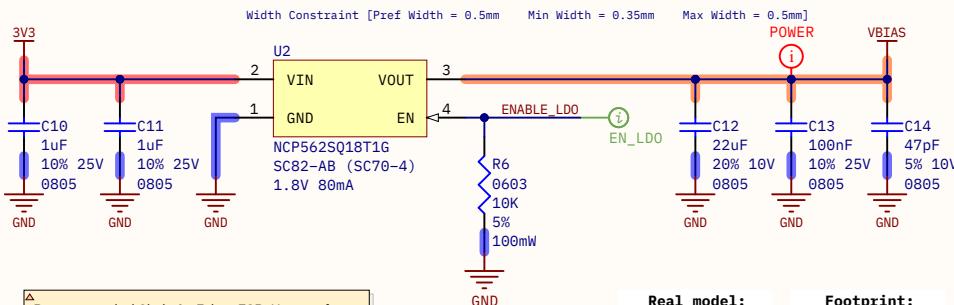


Typical Application Circuit. [AP3429/A datasheet, page 2] with some values modified as needed and/or part availability. Capacitors should be placed close to the chip and circuit should be traced in short loops. Feedback voltage V_{FB} is 0.6 V const.

Resistors are adjusted as a voltage divider. So, if 3.3V are needed at the converter output: $V_{FB} = 0.6V = V_{out} \cdot (R2)/(R1+R2) \rightarrow R2 = 2/9 \cdot R1$. Resistor values must be high (kOhms) in order to maintain a low power consumption on the feedback circuit.



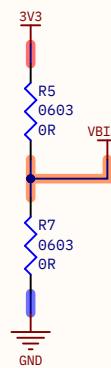
1.8 V rail: Vbias for signal conditioning circuit



Recommended C_{in} is 1 μ F, low ESR. Usage of multiple input capacitors to reduce ESR and ESL. There are no recommended values for C_{out} but these caps should probe more than enough to have low ESR and reduce ripple at a wide frequency range. Datasheet specifies a typical 100 μ Vrms noise on V_{out} , somewhat high.

Optional 1V8 rail bypass jumpers

IMPORTANT:
1V8 rail is bypassable by soldering these optional 0- Ω resistors. This is for experimenting with different voltages and if it affects the overall performance of the acquisition circuit.
Do NOT connect both OR resistors at the same time or it will jump VCC and GND. And keep the LDO disabled at all times.



This can also be used to insert a voltage divider. i.e.: if you want to reduce the rail voltage to $V_{CC}/2$ you only have to add two ≥ 10 K Ω 0603 resistors. Just keep in mind that voltage won't be as stable as in a LDO as it will be greatly dependent on the load impedance.

If you do this, populate the LDO's output caps, so VBIAS it behaves as a small-signal GND.

Power rails

Battery DC/DC step-down converter and Vbias for signal conditioning circuit.

Designer's signature
Supervisor's signature

Sheet title: *
Project title: TIK_HandheldDevice.PjPcb

Designer: Juan Del Pino Mena

Date: 2022-05-12 Revision: 0.4-WIP Sheet 7 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain



Battery charging circuit variants

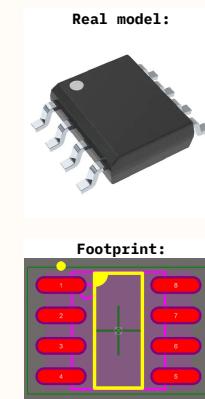
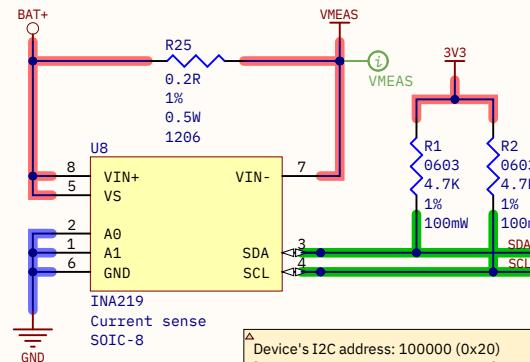
BATTERY CHARGER [VARIANT #1: NiMH]
battery_charger_ni_mh



BATTERY CHARGER [VARIANT #2: Li-ION]
battery_charger_li-ion

Two circuit variants are implemented BUT NOT USED SIMULTANEOUSLY. Only one must be populated at a time.
The usage of one over the other will come by component disponibility.

Battery output current sense and voltage monitor



Battery connector. Charger selection jumper. Battery thermistor

Width Constraint [Pref Width = 0.5mm Min Width = 0.35mm Max Width = 0.5mm]

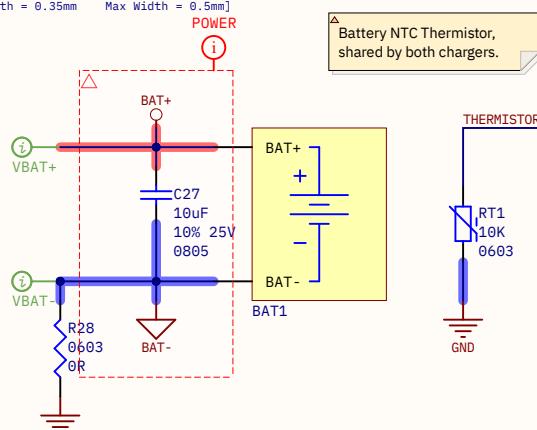
IMPORTANT: 0-Ohm jumper for charger selection:

The battery share the connector between the 2 possible chargers.

However, on the Lithium one BAT- is not connected to the system GND for protection; but in the case of the NiMH one it is.

So, to avoid shorting BAT- and GND on the Li-Ion charger, DO NOT place the 0-ohm jumper.

On the other hand if you are using the NiMH charger solder you MUST use the jumper.

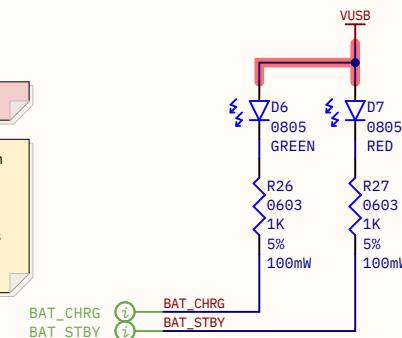


Charging status indicator

These signals come from both charging IC's.

They are status outputs that are normally on high impedance and they are pulled LOW when activated.

We can use these pins to turn on some LEDs and to notify the microcontroller of the charging status.



Battery and current sense

Two circuit variants that will be implemented but not used simultaneously. The usage of one over the other will come by component disponibility. INA219 current sensor is independent and common for both systems.

Designer's signature

Sheet title: **Battery and current sense**

Project title: **TIK_HandheldDevice.PjPcb**

Supervisor's signature

Desinger: **Juan Del Pino Mena**

Date: **2022-05-12**

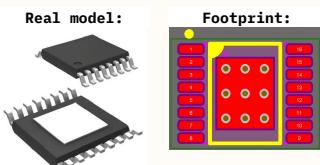
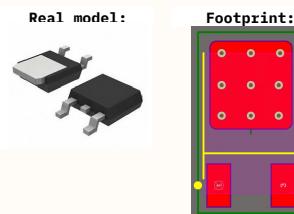
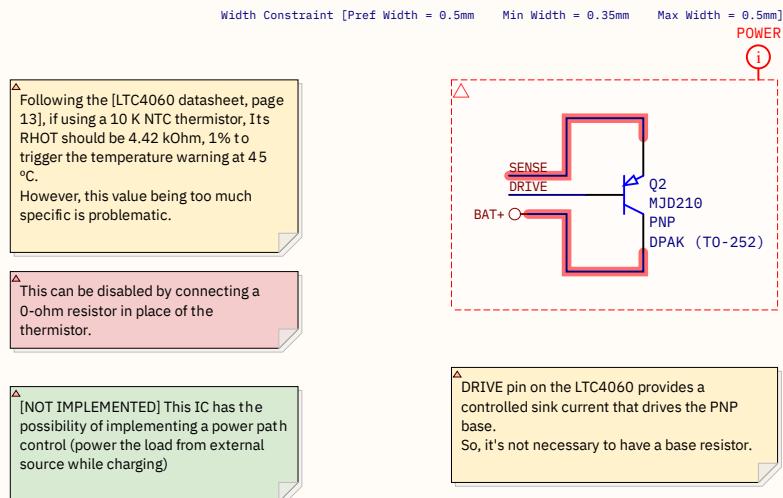
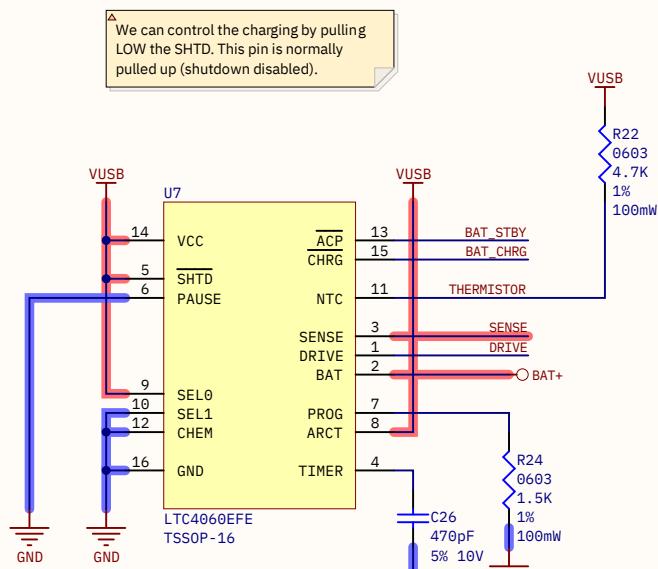
Revision: **0.4-WIP**

Sheet 8 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain



NiMH/NiCd battery charger IC



△ TIMER capacitor and PROG resistor program the charge Tmax (maximum charging time, a security measure). [LTC4060 datasheet, page 13]. These values should complete a full charge in at most 1 h 6'

△ PROG resistor programs the maximum current that the battery will receive while charging. For 1.5 kOhm this is 0.93 A.

△ i.e.: a 1000 mAh battery will charge at approx 1C with this configuration, but can be insufficient time for a 3000 mAh one.

Battery charging circuitry for Ni-MH

Battery charger circuit variant #1. By default the device uses a Nickel-metal hydride battery which are chemically and thermally more stable (and safer) than Lithium-based ones; at the cost of a lower charge/volume ratio.

Designer's signature
Supervisor's signature

Sheet title: **Battery charger**
Project title: **TIK_HandheldDevice.PjPcb**

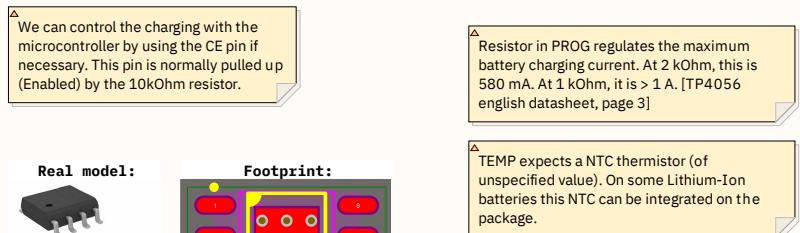
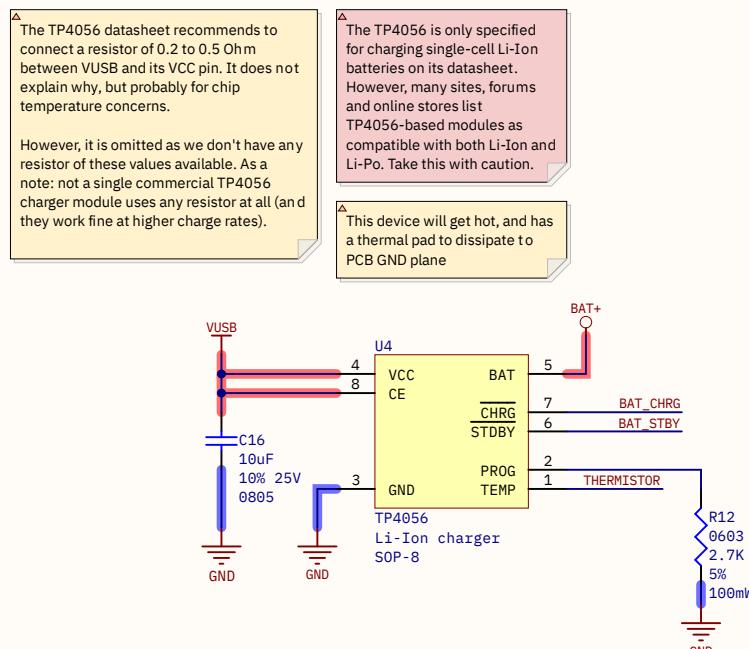
Designer: **Juan Del Pino Mena**

Date: **2022-05-12** Revision: **0.4-WIP** Sheet 9 of 18

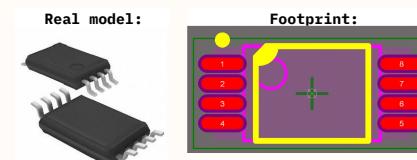
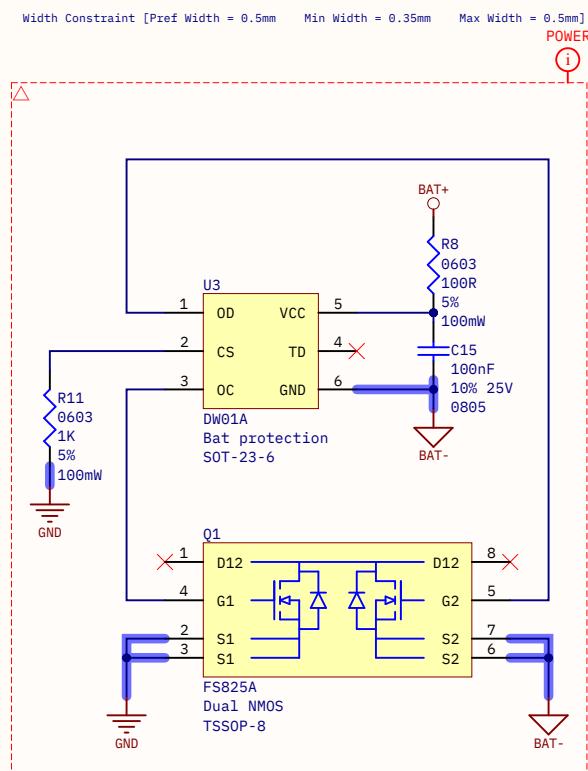
Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología
de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain



Lithium battery charger IC



Lithium battery protection



Battery charging circuitry for Li-Ion

Battery charger circuit variant #2.

This circuit must NOT be placed if the Ni-MH charger is present on the board (and vice-versa).

Designer's signature
Supervisor's signature

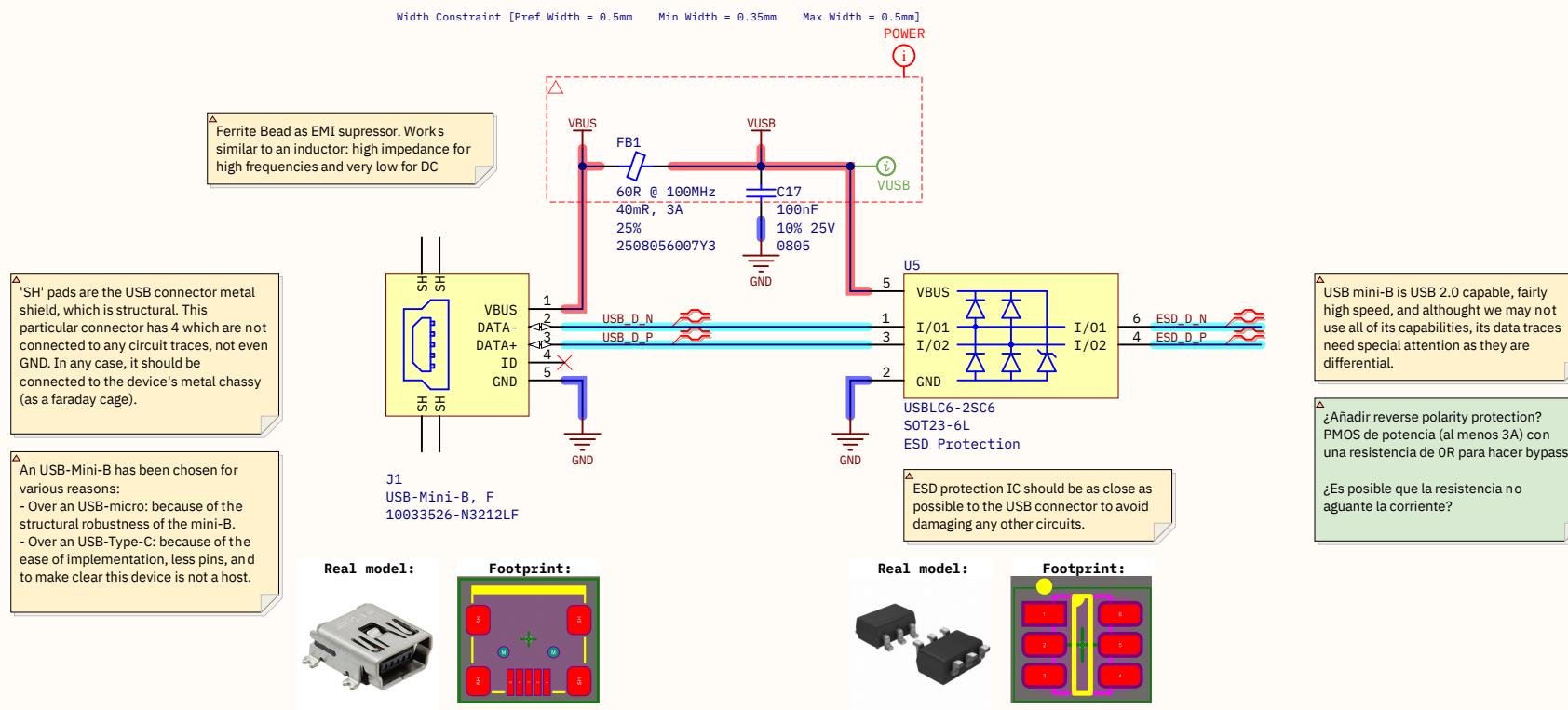
Sheet title: **Battery charger**
Project title: **TIK_HandheldDevice.PjPcb**

Desinger: **Juan Del Pino Mena**

Date: **2022-05-12** Revision: **0.4-WIP** Sheet 10 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain





USB connector and ESD protection circuit

USB is used as a programming interface, as well as a power source for the charging circuit. Since it's an external connector, it needs to have a protection circuit against electro-static discharge (ESD) and noise.

Designer's signature

Supervisor's signature

Sheet title: **USB connector and ESD protection circuit**

Project title: **TIK_HandheldDevice.PxjPcb**

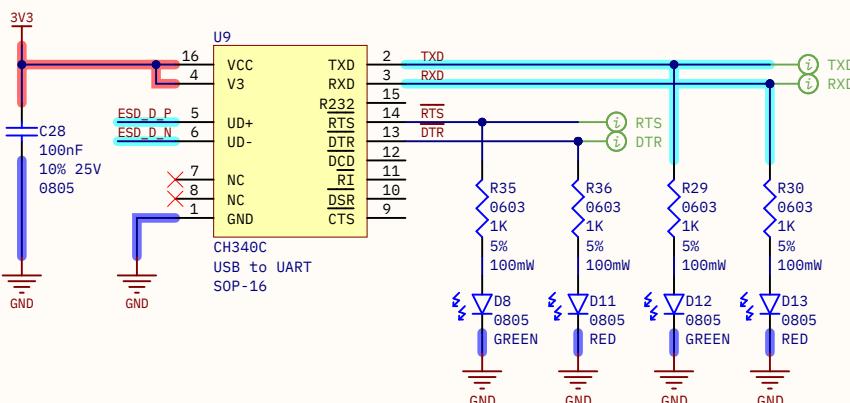
Designer: **Juan Del Pino Mena**

Date: **2022-05-12** Revision: **0.4-WIP** Sheet 11 of 18

Supervisor:
 Sr. Andrés Roldán Aranda
 Dpto. Electrónica y Tecnología
 de Computadores
 University of Granada
 C/Fuente Nueva, s/n. 18001
 Granada, Granada, Spain



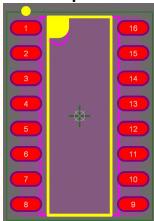
USB to UART conversion



Real model:

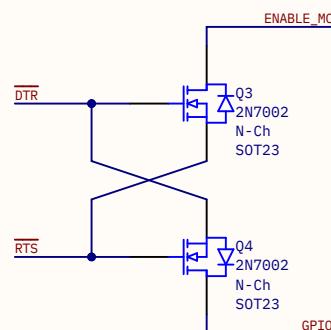


Footprint:



These LEDs serve as testimonies of
UART communication and help
during debugging process

Auto programming circuit



[△] ESP32 GPIO00 is a Strapping pin. Strapping pins modify the device's boot mode during chip reset (enable pin pulled down)
GPIO00 is pulled up during reset. ESP_ENABLE is pulled up by an external pullup resistor

When GPIO0 is HIGH, it boots from internal SPI memory, but when it's LOW the boot sequence changes to 'Download' and we can upload a program to the MCU.

[ESP32 Datasheet, section 2.4, pages 19-20]

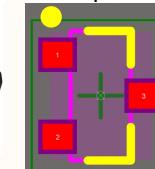
Circuit truth table

DTR	RTS	ENABLE_MCU	GPIO00
0	0	1	1
0	1	1	0
1	0	0	1
1	1	1	1

Real model:



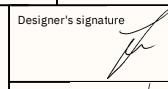
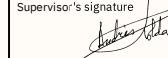
Footprint:



USB to UART and MCU programming

*

*

Designer's signature

Supervisor's signature


Sheet title: **USB to UART and MCU programming**

Project title: **TIK_HandheldDevice.PjPcb**

Designer: **Juan Del Pino Mena**

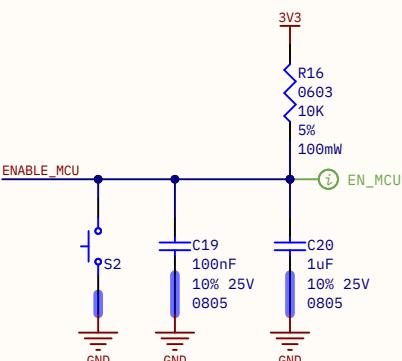
Date: **2022-05-12** Revision: **0.4-WIP** Sheet 12 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología
de Computadores
University of Granada
C/Fuente Nueva, s/n. 18001
Granada, Granada, Spain

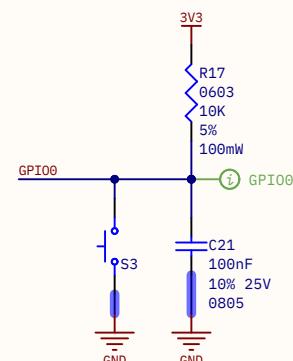


Reset

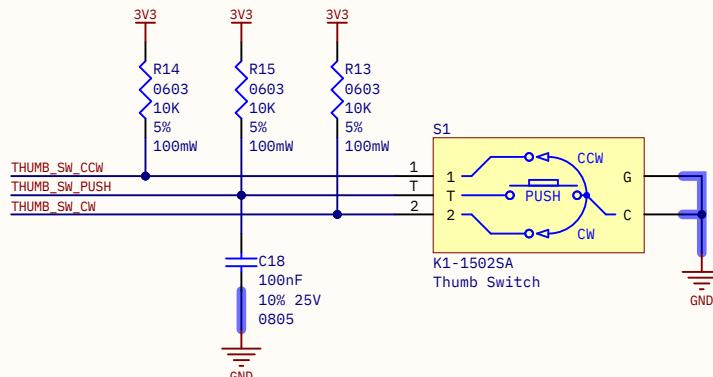
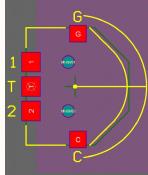
To ensure power stability to the microcontroller during powerup, this RC filter introduces a delay on the ENABLE pin. Usual values are $10\text{ k}\Omega$, $1\text{ }\mu\text{F}$ ($\tau = 10\text{ ms}$, $t_{\{10-90\}} = 22\text{ ms}$).
[ESP32-WROOM-32D datasheet, page 22]

**Boot mode selection (debug)**

Allows to force 'Download' boot sequence
Same design as in ESP32 DevKit boards.
100 nF cap are for debouncing and should be placed close to the buttons

**Multidirection 'thumb' button (UI navigation)**

Horizontal SMD device, multi-directional / muti-function rotary slider button.
Accessed from the right side.

**Real model:****Footprint:****Buttons**

TFT LCD touchscreen, rotary encoder, on/off and reset switches

*

Designer's signature
Supervisor's signature

Sheet title: **Buttons**
Project title: **TIK_HandheldDevice.PjPcb**

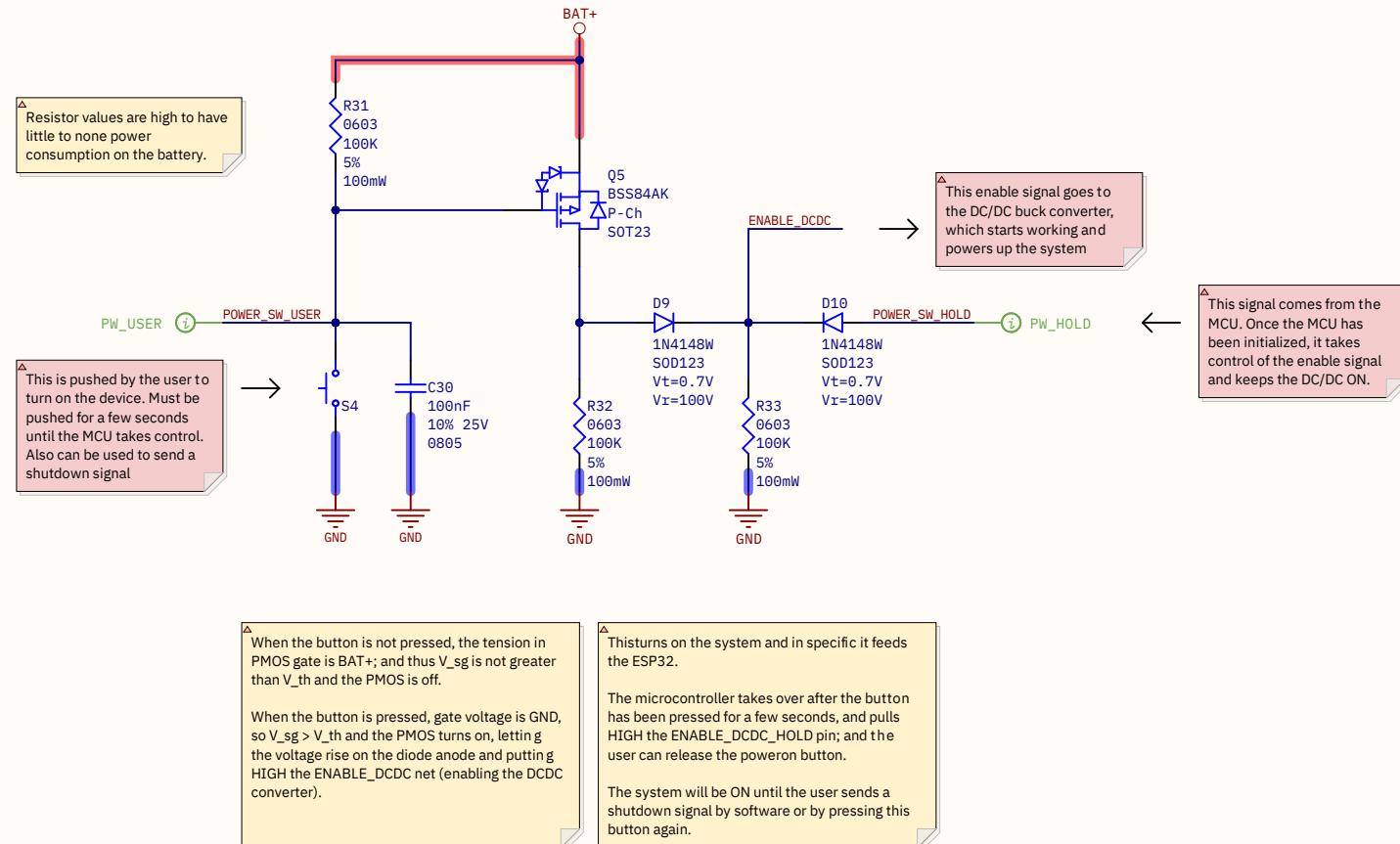
Designer: **Juan Del Pino Mena**

Date: **2022-05-12** Revision: **0.4-WIP** Sheet 13 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología
de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain



A



Powerup button

*

*

Designer's signature
Supervisor's signature

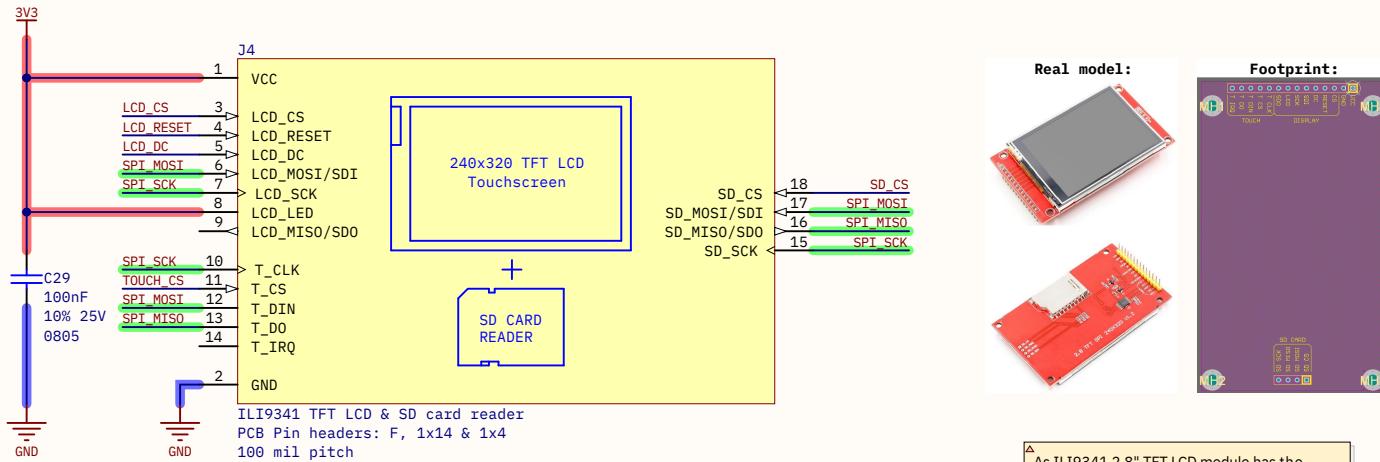
Sheet title: **Powerup button**
Project title: **TIK_HandheldDevice.PjPcb**

Designer: **Juan Del Pino Mena**

Date: **2022-05-12** Revision: **0.4-WIP** Sheet 14 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología de Computadores
University of Granada
C/Fuente Nueva, s/n. 18001
Granada, Granada, Spain

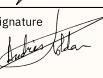




LCD TFT Touch Display & SD card reader

*
*

Designer's signature

Supervisor's signature


Sheet title: LCD TFT Touch Display & SD card reader

Project title: TIK_HandheldDevice.PjPcb

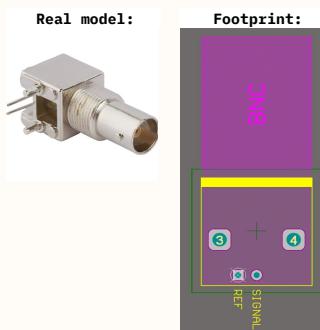
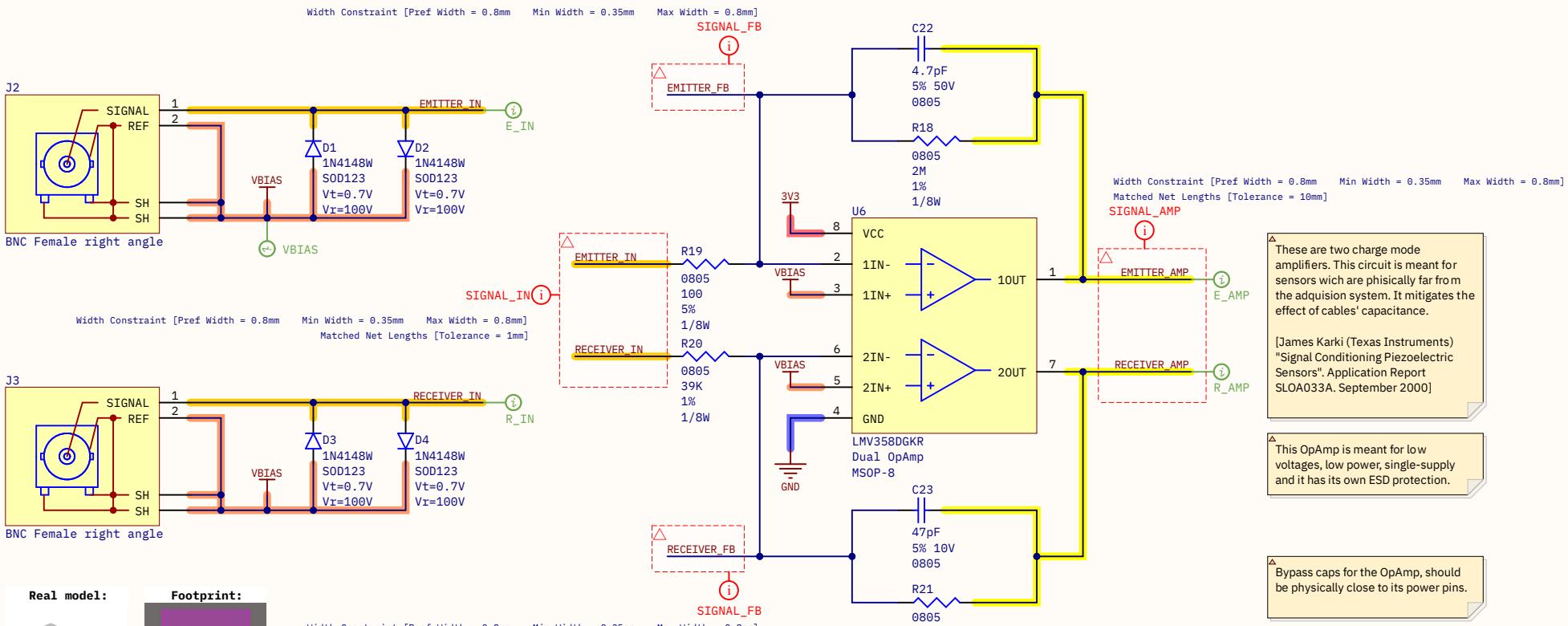
Designer: Juan Del Pino Mena

Date: 2022-05-12 Revision: 0.4-WIP Sheet 15 of 18

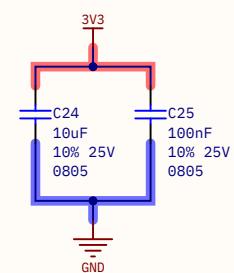
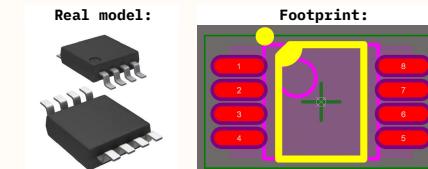
Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología
de Computadores
University of Granada
C/Fuente Nueva, s/n. 18001
Granada, Granada, Spain



A



Emitter signal will be in the range of 15 V to 100 V and need to be clipped. Then, the OpAmp will amplify by perceived by the instrument as a flank; whereas receiver signal most likely will be amplified without any clipping.



Signal conditioning circuit

Signal comes from piezoelectric sensors and need to be converted from charge to voltage. Three sensors that have been used for this project proved to generate up to -100 volts peak, so it needs clipping

Designer's signature
Supervisor's signature

Sheet title: **Signal conditioning circuit**

Project title: **TIK_HandheldDevice.PjPcb**

Designer: **Juan Del Pino Mena**

Date: **2022-05-12**

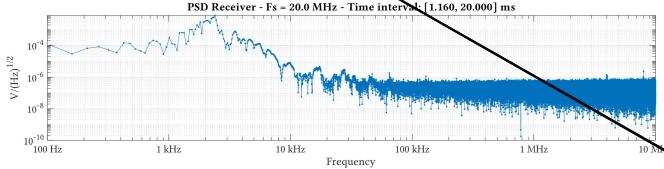
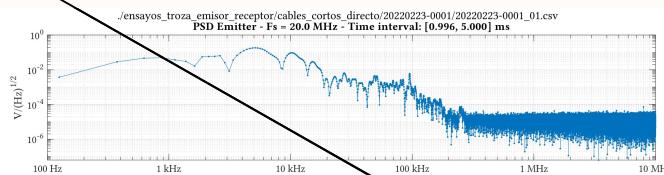
Revision: **0.4-WIP**

Sheet 16 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain

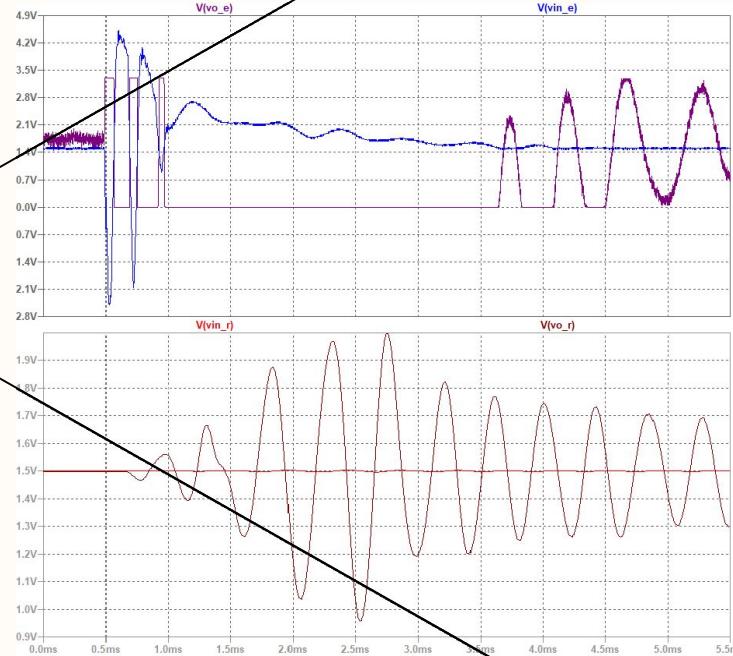


Example of a Voltage Spectral Density of trunk signals

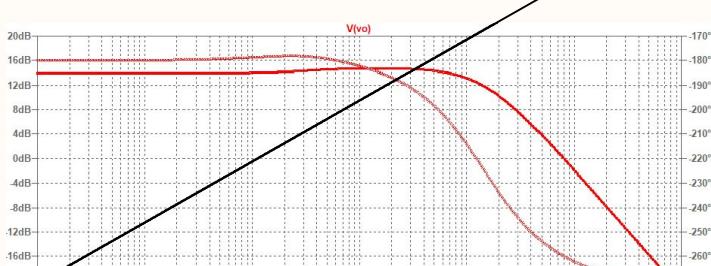
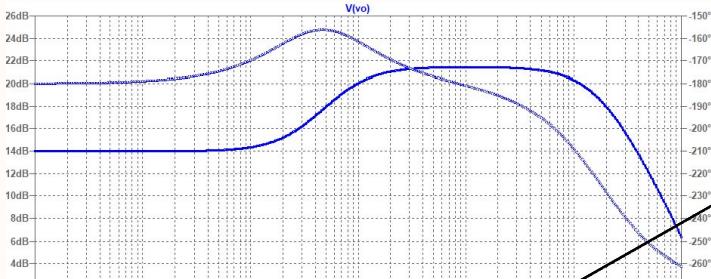


A REVISAR Y REPETIR EN ALTIUM

Time behavior



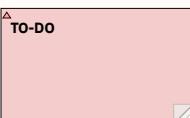
Conditioning circuit theoretical frequency response



Respuesta en frecuencia teórica, con el modelo UniversalOpAmp, cable con 700 pF y R del piezo 2 M Ω
¿Afecta en algo la fase?

Signal conditioning theorecticals

*
*



Designer's signature
Supervisor's signature

Sheet title: Signal Conditioning Theorecticals

Project title: TIK_HandheldDevice.PxjPcb

Desinger: Juan Del Pino Mena

Date: 2022-05-12 Revision: 0.4-WIP Sheet 17 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain



A

A

B

B

C

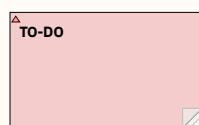
C

D

D

Power budget

*
*



Designer's signature

Supervisor's signature

Sheet title: **Power budget**

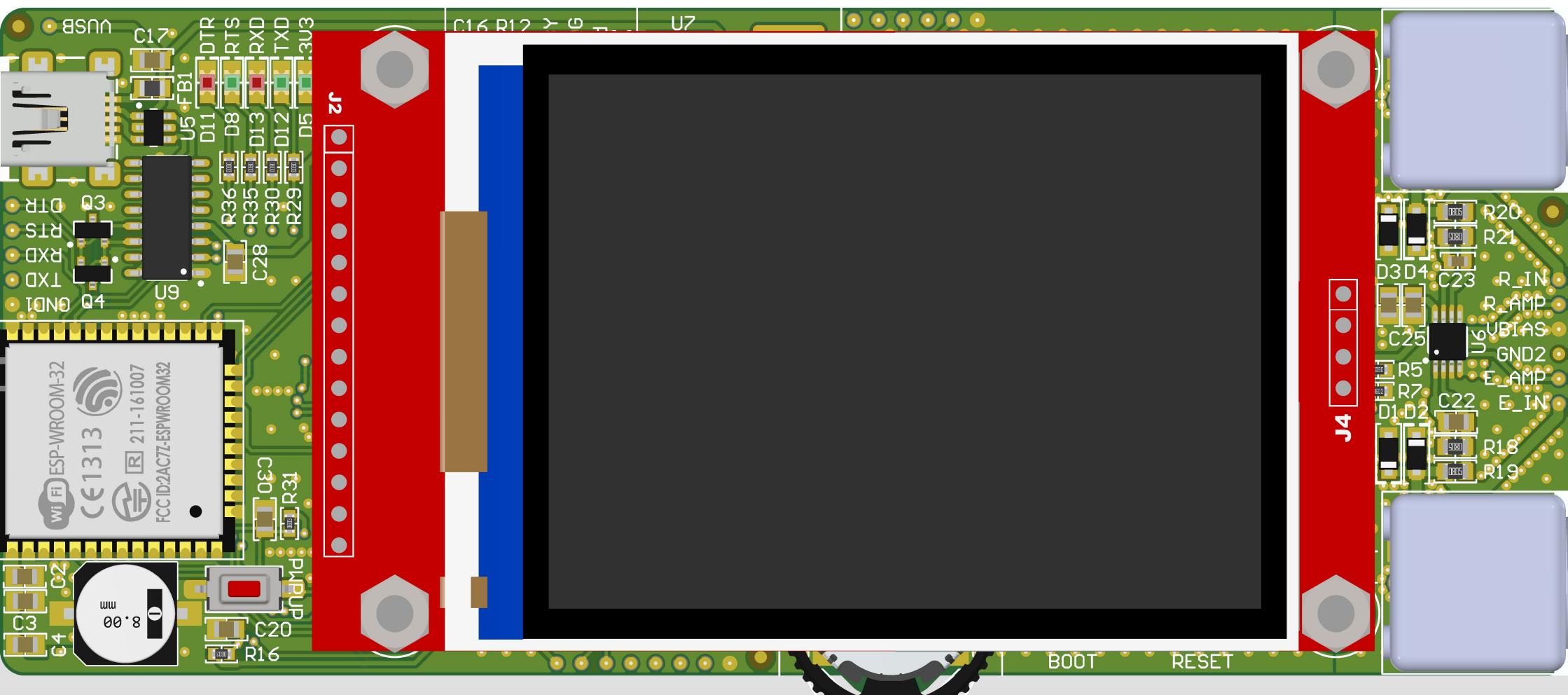
Project title: **TIK_HandheldDevice.PxjPcb**

Designer: **Juan Del Pino Mena**

Date: **2022-05-12** Revision: **0.4-WIP** Sheet 18 of 18

Supervisor:
Sr. Andrés Roldán Aranda
Dpto. Electrónica y Tecnología
de Computadores
University of Granada
C/Fuente Nueva, s/n, 18001
Granada, Granada, Spain





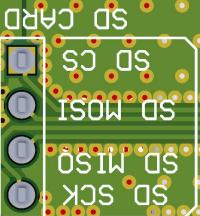
**RECEIVER
[STOP]**

**EMITTER
[START]**

TIK handheld device

2022-05-12 rey 0.4-WIP

Juan Del Pino Mena github.com/dpmj



THUMB BUTTON

SD CARD SLOT

BAT_STBY
BAT_CHRG
UBAT+
UBAT-
UIMEAS
GND4

GND3
EN_LDO
EN_DDC
PUL_USER
PUL_HOLD
EN MCU
GP100
3V3

DISPLAY
Touch

UCC
GND
CS
RESET
DC
SDI
SCK
LED
SDO
T CLK
T CS
T DIN
T DO
T IRQ



✓ RoHS
Pb-free

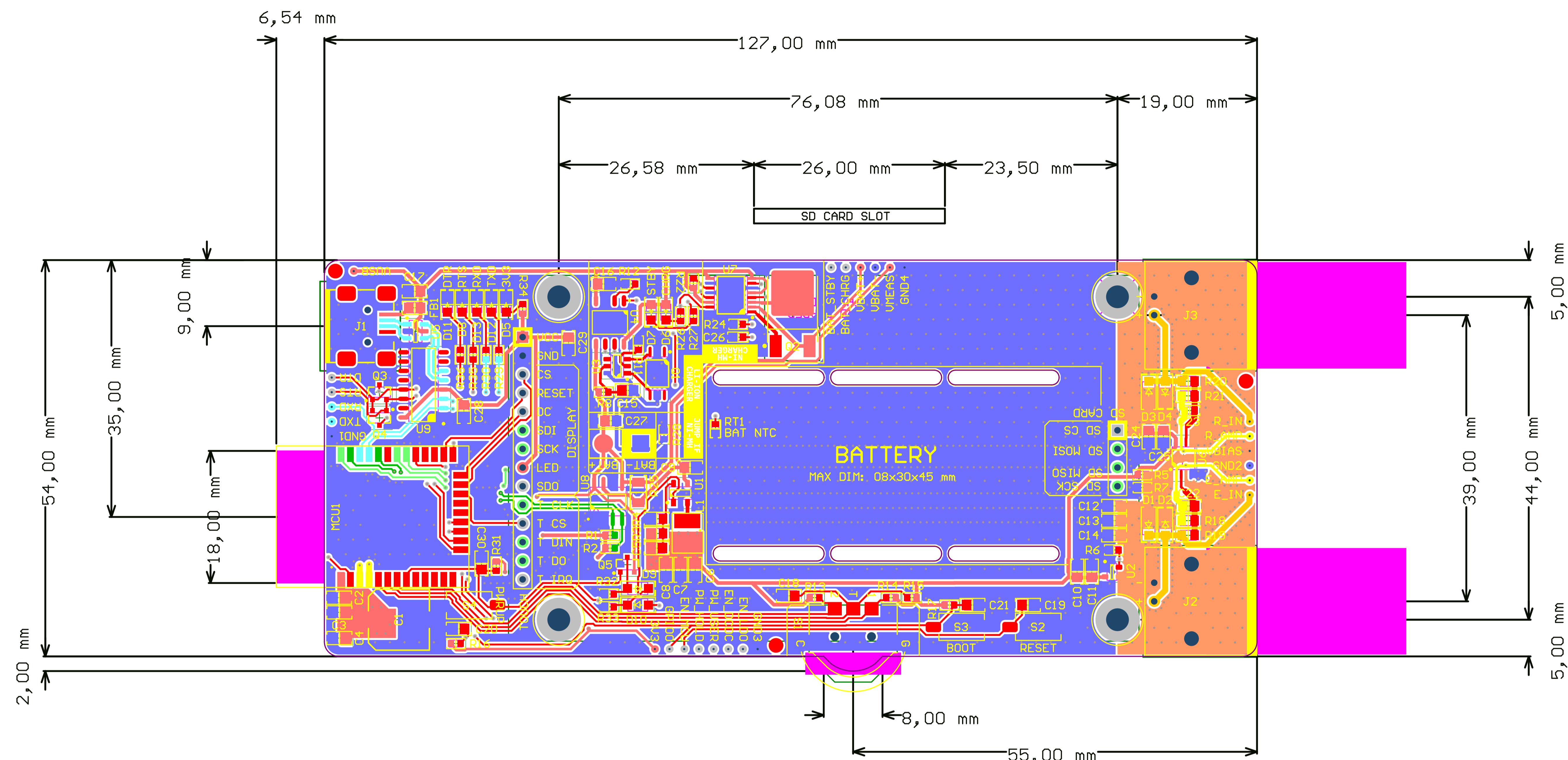


USB

USB

ESP32 ANTENNA

A



TIK handheld device PCB

PCB orientation: vertical. Screen facing front, BNCs on top, USB at the bottom, SD Card reader at the left, powerup button at the bottom front right, and multipurpose button on the right side.

Designer's signature:

Supervisor's signature:

Sheet title: TIK Handheld Device PCB

Project title: TIK_HandheldDevice

Designer: Juan Del Pino Mena

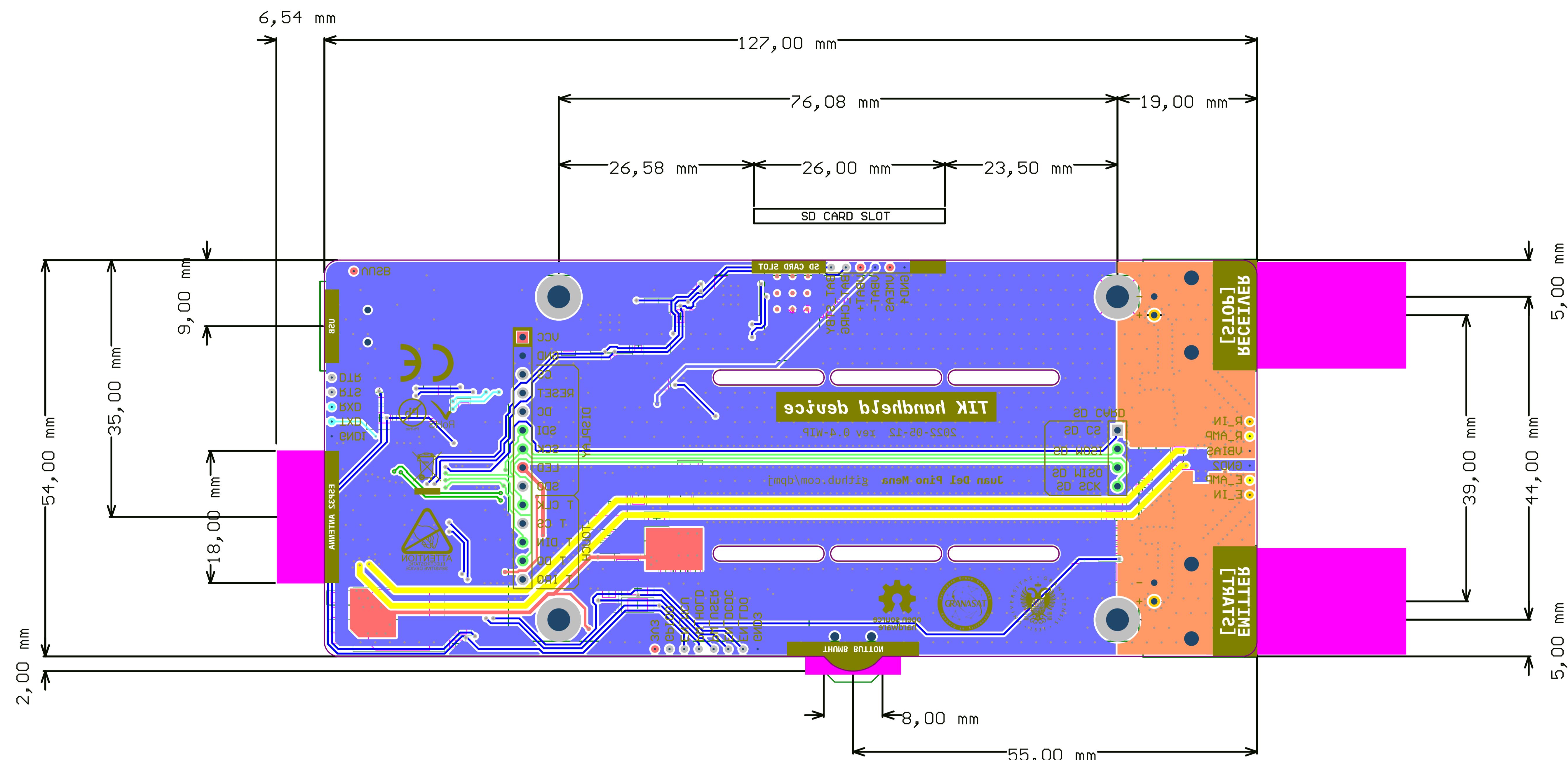
Supervisor: Andres Roldan Aranda

Dpto. Electronica y Tecnologia
de Computadores
University of Granada
C/ Fuente Nueva, s/n, 18001
Granada, Granada, Spain
Sr. Andres Roldan Aranda

Date: 2022-05-12
Revision: 0.4-WIP Sheet 1 of 1



A

**VISIBLE LAYERS:**

Board outline + Multilayer + Bottom overlay + Bottom layer + Keep-out + dimensions

TRACKS & POLYGONS COLOR LEGEND:

EMITTER/RECEIVER ANALOG SIGNALS	POWER REFERENCE GND/BAT-	SPI
GENERIC NET ON TOP LAYER	POWER RAIL 3V3/BAT+/VUSB/VMEAS/VSENSE	I2C
GENERIC NET ON BOTTOM LAYER	POWER RAIL VBIAS	SERIAL UART/USB

TIK handheld device PCB

PCB orientation: vertical. Screen facing front, BNCs on top, USB at the bottom, SD Card reader at the left, powerup button at the bottom front right, and multipurpose button on the right side.

Designer's signature:

Sheet title: TIK Handheld Device PCB

Supervisor's signature:

Project title: TIK_HandheldDevice

Designer: Juan Del Pino Mena

Supervisor: Andres Roldan Aranda

Dpto. Electronica y Tecnologia
de Computadores
University of Granada
C/ Fuente Nueva, s/n, 18001
Granada, Granada, Spain
Sr. Andres Roldan Aranda

Date: 2022-05-12
Revision: 0.4-WIP Sheet 1 of 1

